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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

ര്ള ക്രൂഷ്ട്ര് ation of: Han et al.

Application No: 10/821,123 Confirmation No: 6448

Filed: April 13, 2004

Title: PROCESS CHAMBER COMPONENT

HAVING ELECTROPLATED YTTRIUM

CONTAINING COATING

Group Art Unit: 1794

Examiner: Michael E. Lavilla

Attorney Docket No:

003330 USA P01/ETCH/METAL/MDD

February 19, 2008

San Francisco. California

## SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## Sir/Madam:

Attached hereto is a PTO-SB08 form listing documents believed relevant to the subject application. It is respectfully requested that these documents be considered by the Examiner and an initialed copy of the form be returned to the undersigned.

US patent 6,004,631 A1 is believed to be the US equivalent of Korean publication 10-0375080.

Applicant believes this Information Disclosure Statement should be considered by the Office because it is being filed before the payment of the issue fee, and each item of information contained in the Information Disclosure Statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the Information Disclosure Statement. The Commissioner is hereby authorized to charge the fee set forth in 37 C.F.R. §1.17(p) to Deposit Account No. 10-0258.

02/26/2008 SSITHIB1 00000017 100258 10821123

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## CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, or facsimile transmitted to the U.S. Patent and Trademark Office at (571) 273-8300 or submitted electronically via EFS on the date shown below.

By: Amy Wells

Date: 02-19-2008

Docket No: 003330 USA P01/ETCH/METAL/MDD

Appl. No.: 10/824,123

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It is believed that this disclosure complies with the requirements of 37 C.F.R.

§§ 1.56, 1.97, and 1.98, and the Manual of Patent Examining Procedures §707.05(b). If for some

Reason the Examiner considers otherwise, it is respectfully requested that the undersigned be

called so that any deficiencies can be remedied.

Except for US patents and published US patent applications, a copy of each

document is enclosed.

Some of the documents may have markings thereon. No significance is meant to

be attached to the markings.

With regard to any translations which may be provided herewith, the undersigned

does not know how the translations were made, or by whom the translations were made.

Therefore, no representation is being made as to the accuracy of any translation.

These documents are not necessarily analogous.

If the examiner has any questions concerning this document, please call the

undersigned at: (415) 538-1555.

Respectfully submitted,

JANAH & ASSOCIATES, P.C.

By:

Ashok K. Janah

Reg. No. 37,487

Please send all correspondence to:

Janah & Associates, P.C. 650 Delancey Street, Suite 106

San Francisco, CA 94107

Encl.